

UNISONIC TECHNOLOGIES CO., LTD

20N40K-MT

Preliminary

Power MOSFET

20A, 400V N-CHANNEL POWER MOSFET

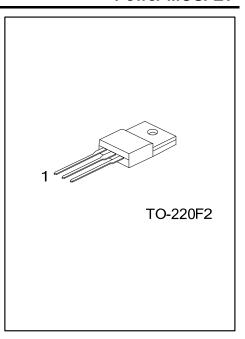
■ DESCRIPTION

The UTC **20N40K-MT** is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

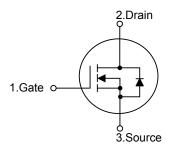
The UTC **20N40K-MT** is generally applied in high efficiency switch mode power supplies.



^{*} $R_{DS(ON)}$ < 0.22 Ω @ V_{GS} = 10V, I_{D} = 10A



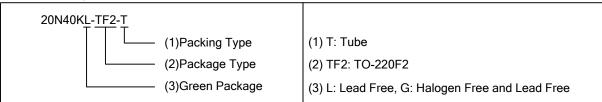
■ SYMBOL



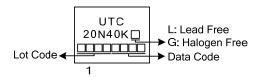
■ ORDERING INFORMATION

Ordering	Dealtage	Pin	Dooking				
Lead Free	Halogen Free	Package	1	2	3	Packing	
20N40KL-TF2-T	20N40KG-TF2-T	TO-220F2	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



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^{*} High Switching Speed

■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT	
Drain-Source Voltage			V_{DSS}	400	V	
Gate-Source Voltage			V_{GSS}	±30	V	
Drain Current	Continuous	T _C =25°C	I _D	20	Α	
Drain Current	Pulsed (Note 2)		I _{DM}	80	Α	
Avalanche Current (Note 2)		I _{AR}	20	Α		
Avalanche Energy Single Pulsed (Note 3)			E _{AS}	1000	mJ	
Peak Diode Recovery dv/dt (Note 4)			dv/dt	4.5	V/ns	
Power Dissipation (T _C =25°C)			D	45	W	
Derate above 25°C			P_D	0.35	W/°C	
Junction Temperature			T_J	+150	°C	
Storage Temperature			T_{STG}	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 5.01mH, I_{AS} = 20A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 4. $I_{SD} \le 20A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	62.5	°C/W	
Junction to Case	θ_{JC}	2.8	°C/W	

■ ELECTRICAL CHARACTERISTICS

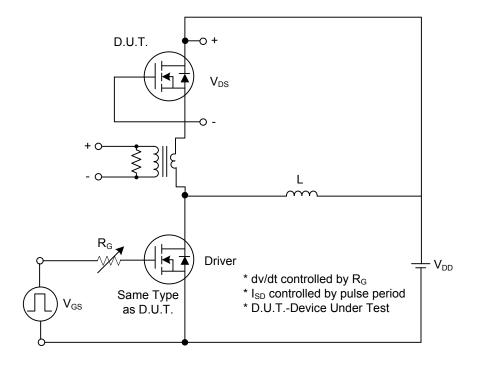
PARAMETER		SYMBOL	TEST CONDITIONS MIN		TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV _{DSS}	$I_D = 250 \mu A, V_{GS} = 0 V$	400			V		
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_{J}$	Reference to 25°C, I _D =250μA		0.5		V/°C		
Drain-Source Leakage Current		I _{DSS}	V _{DS} =400V, V _{GS} =0V			10	μΑ		
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA		
Gate- Source Leakage Current	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V		
Static Drain-Source On-State Re	sistance	R _{DS(ON)}	V _{GS} =10V, I _D =10A		0.15	0.22	Ω		
DYNAMIC PARAMETERS									
Input Capacitance		C _{ISS}			1170		pF		
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		300		pF		
Reverse Transfer Capacitance		C_{RSS}			11.9		pF		
SWITCHING PARAMETERS									
Turn-ON Delay Time		t _{D(ON)}			110		ns		
Rise Time		t_R	V_{DS} =30V, I_{D} =0.5A, R_{G} =25 Ω		190		ns		
Turn-OFF Delay Time		t _{D(OFF)}	(Note 1, 2)		372		ns		
Fall-Time		t_{F}			200		ns		
Total Gate Charge at 10V		$Q_{G(TOT)}$	\/ -10\/ \/ -50\/ \ -1 3A		57		nC		
Gate to Source Charge		Q_GS	V _{GS} =10V, V _{DS} =50V, I _D =1.3A (Note 1, 2)		15		nC		
Gate to Drain Charge		Q_GD	(Note 1, 2)		16		nC		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS									
Maximum Body-Diode Continuous Current		Is				20	Α		
Maximum Body-Diode Pulsed Cu	urrent	I _{SM}				80	Α		
Drain-Source Diode Forward Voltage		V_{SD}	I _{SD} =23A, V _{GS} =0V			1.5	V		

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

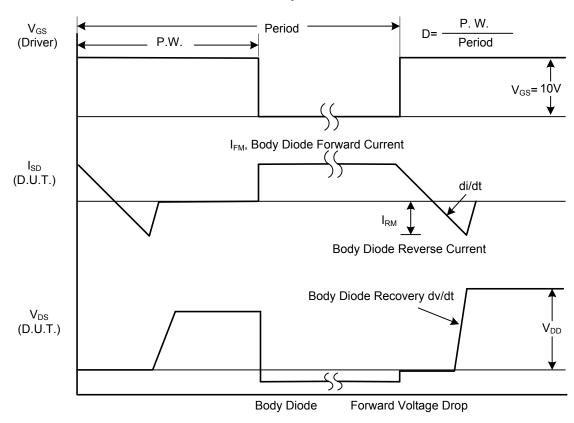
2. Essentially Independent of Operating Temperature Typical Characteristics



■ TEST CIRCUITS AND WAVEFORMS

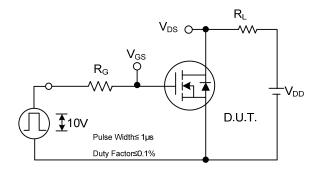


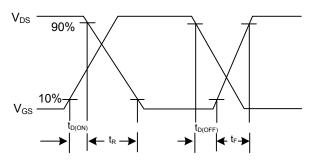
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

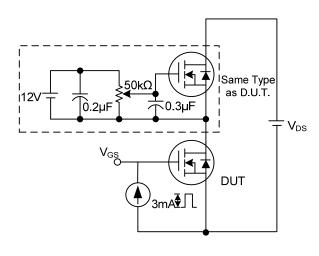
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

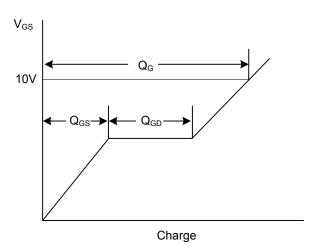




Switching Test Circuit

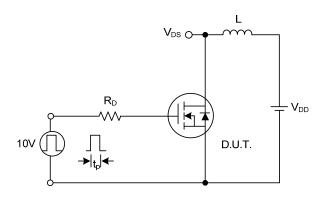
Switching Waveforms

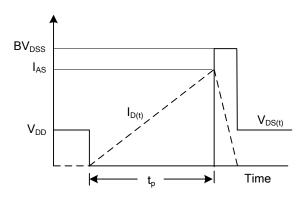




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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